



Material Content Data Sheet



Sales Product Name		IPD70R1K4P7S		Issued		24. January 2018		
MA#		MA001493886						
Package		PG-TO252-3-344		Weight*		321.44 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.908	0.28	0.28	2825	2825
leadframe	inorganic material	phosphorus	7723-14-0	0.043	0.01		134	
	non noble metal	iron	7439-89-6	0.144	0.04		448	
	non noble metal	copper	7440-50-8	143.904	44.79	44.84	447679	448261
	non noble metal	aluminium	7429-90-5	0.141	0.04	0.04	438	438
wire	non noble metal	aluminium	7429-90-5	0.141	0.04	0.04	438	438
encapsulation	organic material	carbon black	1333-86-4	0.690	0.21		2148	
	plastics	epoxy resin	-	18.643	5.80		57999	
	inorganic material	silicondioxide	60676-86-0	118.765	36.95	42.96	369474	429621
leadfinish	non noble metal	tin	7440-31-5	3.834	1.19	1.19	11926	11926
solder	non noble metal	tin	7440-31-5	0.027	0.01		83	
	noble metal	silver	7440-22-4	0.033	0.01		104	
	non noble metal	lead	7439-92-1	1.274	0.40	0.42	3963	4150
heatspreader	inorganic material	phosphorus	7723-14-0	0.010	0.00		31	
	non noble metal	iron	7439-89-6	0.033	0.01		103	
	non noble metal	copper	7440-50-8	32.995	10.26	10.27	102645	102779
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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